FGP30B, FGP30C, FGP30D

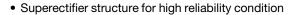
Vishay General Semiconductor

Glass Passivated Ultrafast Plastic Rectifier



PRIMARY CHARACTERISTICS				
I _{F(AV)}	3.0 A			
V_{RRM}	100 V, 150 V, 200 V			
I _{FSM}	125 A			
t _{rr}	35 ns			
V _F	0.95 V			
I _R	5.0 μA			
T _J max.	175 °C			
Package	DO-204AC (DO-15)			
Diode variations	Single die			

FEATURES





RoHS

- Cavity-free glass-passivated junction
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low switching losses, high efficiency
- Low switching losses, riight emolen
- High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

MECHANICAL DATA

Case: DO-204AC, molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	FGP30B	FGP30C	FGP30D	UNIT	
Maximum repetitive peak reverse voltage	V _{RRM}	100	150	200	V	
Maximum RMS voltage	V _{RMS}	70	105	140	V	
Maximum DC blocking voltage	V _{DC}	100	150	200	V	
Maximum average forward rectified current 0.375" (9.5 mm) lead length at $T_A = 25$ °C	I _{F(AV)}	3.0			А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	125			А	
Operating junction and storage temperature range	T _J , T _{STG}	- 65 to + 175			°C	



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	FGP30B	FGP30C	FGP30D	UNIT
Maximum instantaneous forward voltage	3.0 A		V _F ⁽¹⁾	0.95			V
Maximum DC reverse current at		T _A = 25 °C	I _R	5.0		μA	
rated DC blocking voltage		T _A = 100 °C	'H		50		μπ
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	35			ns
Typical junction capacitance	4.0 V, 1	MHz	CJ	70		pF	

Note

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	OL FGP30B FGP30C FGP30D		UNIT		
Typical thermal resistance	R _{0JA} (1)	55			°C/W	
Typical thermal resistance	R _{0JL} (2)	20				

Notes

(1) Thermal resistance from junction to ambient at 0.375" (9.5 mm) lead length and mounted on PCB with 1.1" x 1.1" (30 mm x 30 mm) copper pads

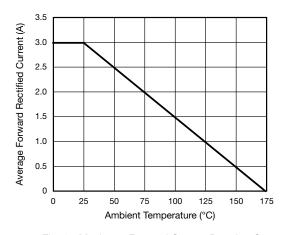
⁽²⁾ Thermal resistance from junction to lead at 0.375" (9.5 mm) lead length with both leads attached to heatsinks

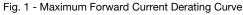
ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
FGP30D-E3/54	0.452	54	4000	13" diameter paper tape and reel		
FGP30D-E3/73	0.452	73	2000	Ammo pack packaging		
FGP30DHE3/54 ⁽¹⁾	0.452	54	4000	13" diameter paper tape and reel		
FGP30DHE3/73 ⁽¹⁾	0.452	73	2000	Ammo pack packaging		

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)





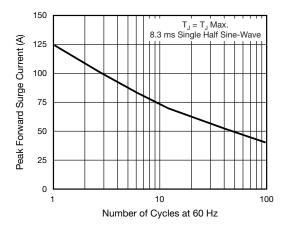


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current



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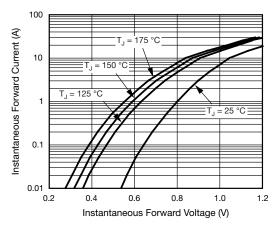


Fig. 3 - Typical Instantaneous Forward Characteristics

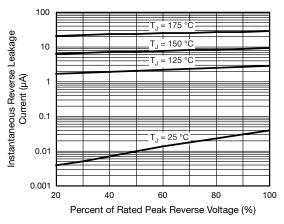


Fig. 4 - Typical Reverse Leakage Characteristics

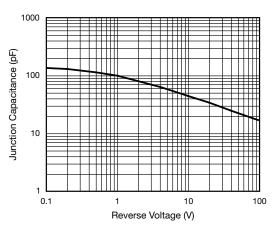


Fig. 5 - Typical Junction Capacitance

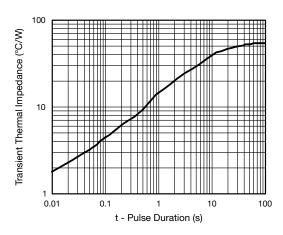
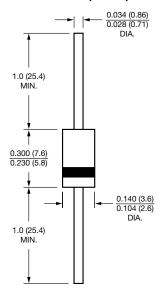


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-204AC (DO-15)





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